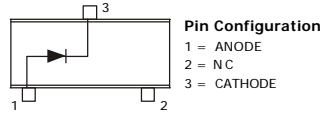
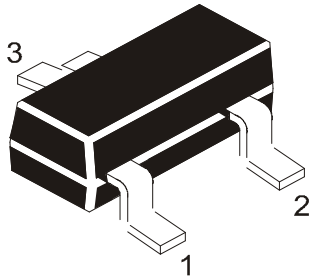


SILICON PLANAR HIGH SPEED DIODES

BAS19, BAS20, BAS21



**SOT-23
Formed SMD Package**

Marking

BAS19 = A8

BAS20 = A81

BAS21 = A82

High-Speed Switching Diodes in a Microminiature Plastic Envelope.

ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

DESCRIPTION	SYMBOL	BAS19	BAS20	BAS21	UNIT
Continuous Reverse Voltage	V_R	100	150	200	V
Repetitive Peak Reverse Voltage	V_{RRM}	120	200	250	V
Non Repetitive Peak Forward Current $t=1\mu s$	I_{FSM}		2.5		A
$t=1s$	I_{FSM}		0.5		A
Average Rectified Forward Current (averaged over any 20 ms period)	$I_F (AV)$		200		mA
Forward Current (DC)	$*I_F$		200		mA
Repetitive Peak Forward Current	I_{FRM}		625		mA
Total Power Dissipation	P_D		250		mW
Storage Temperature Range	T_{stg}		- 55 to +150		°C
Junction Temperature	T_j		150		°C

Thermal Resistance

Junction to Ambient in free air	$R_{th(j-a)}$	500	K/W
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ELECTRICAL CHARACTERISTICS (Ta=25° C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Forward Voltage	V_F	$I_F=100mA$			1.00	V
		$I_F=200mA$			1.25	V
Reverse Breakdown Voltage	$V_{(BR)R}$	$I_R=100\mu A$				
		**BAS19	120			V
		BAS20	200			V
		***BAS21	250			V

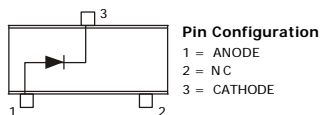
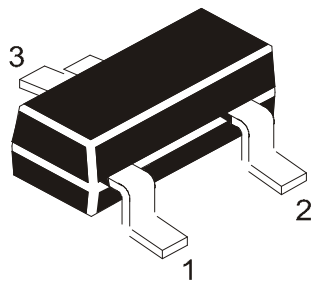
*Mounted on a ceramic substrate Of 8mm x 10mm x 0.7mm

**Measured under pulse conditions; pulse time = $t_p=0.3ms$.

***At zero life time measured under pulse conditions to avoid excessive dissipation and voltage limited to 275V

SILICON PLANAR HIGH SPEED DIODES

BAS19, BAS20, BAS21

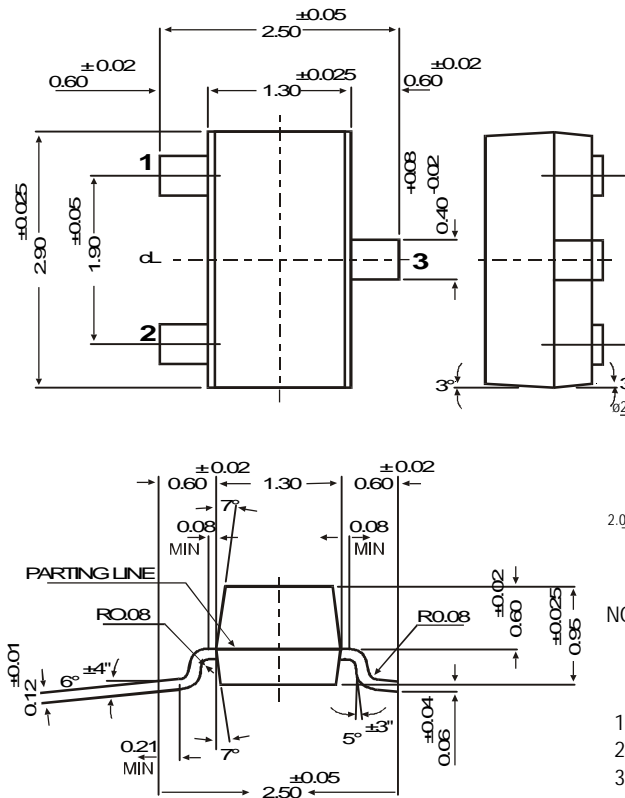


SOT-23
Formed SMD Package

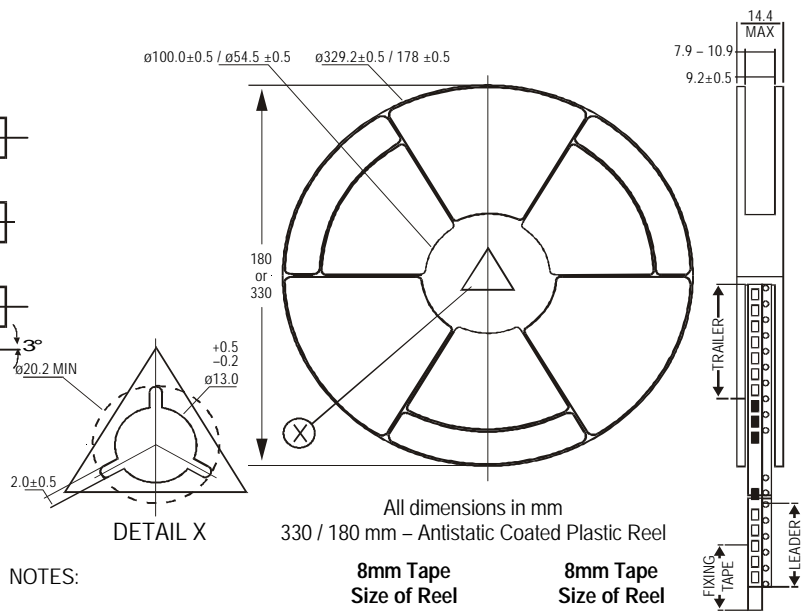
ELECTRICAL CHARACTERISTICS (T_a=25° C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Reverse Voltage Leakage Current	I _R	V _R = V _{Rmax}			100	nA
		V _R = V _{Rmax} T _j = 150°C			100	μA
Differential Resistance	r _{diff}	I _F = 10mA		5		Ω
Reverse Recovery Time When Switched from	t _{rr}	I _F = 30mA to I _R = 30mA, R _L 100 Ω, measured at I _R = 3mA			50	ns

SOT-23 Formed SMD Package



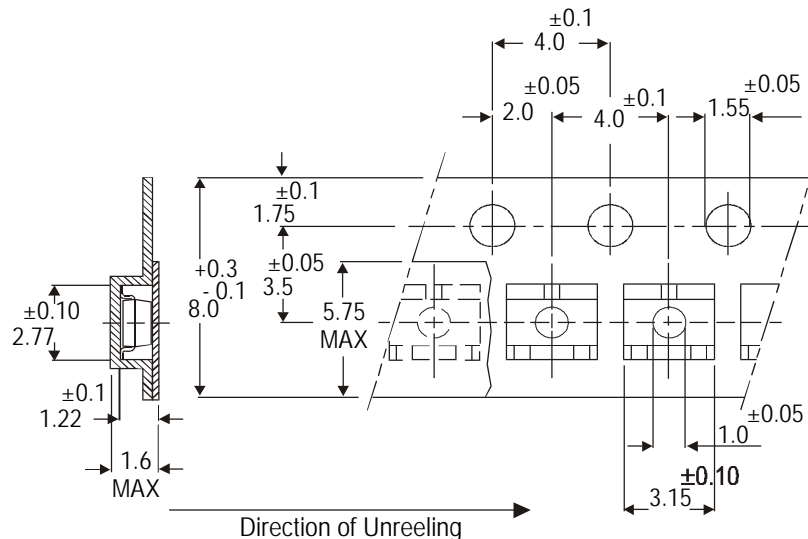
SOT-23 Package Reel Information
Reel Specifications for W Packing (13") and 7"



NOTES:

- | No. of Devices | 8mm Tape
Size of Reel | 8mm Tape
Size of Reel |
|----------------|--------------------------|--------------------------|
| | 330 mm (13") | 180 mm (7") |
| | 10,000 Pcs | 3,000 Pcs |
- The bandolier of 330 mm reel contains at least 10,000 devices.
 - The bandolier of 180 mm reel contains at least 3,000 devices.
 - No more than 0.5% missing devices / reel. 50 empty compartments for 330 mm reel. 15 empty compartments for 180 mm reel.
 - Three consecutive empty places might be found provided this gap is followed by 6 consecutive devices.
 - The carrier tape (leader) starts with at least 75 empty positions (equivalent to 330 mm). In order to fix the carrier tape a self adhesive tape of 20 to 50 mm is applied. At the end of the bandolier at least 40 empty positions (equivalent to 160 mm) are there.

Tape Specification for SOT-23 Surface Mount Device



All dimensions in mm

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
SOT-23 T&R	3K/feel	136 gm/3K pcs	3" x 7.5" x 7.5"	12 K	17" x 15" x 13.5"	192 K	12 kgs
	10K/feel	415 gm/10K pcs	9" x 9" x 9"	51 K	19" x 19" x 19"	408 K	28 kgs
			13" x 13" x 0.5"	10 K	17" x 15" x 13.5"	300 K	16 kgs